





SBOS218A - DECEMBER 2001 - REVISED JUNE 2002

#### **Stereo Audio Volume Control**

#### **FEATURES**

 DIGITALLY-CONTROLLED ANALOG VOLUME CONTROL
 Two Independent Audio Channels
 Serial Control Interface

Serial Control Interface
Zero Crossing Detection
Mute Function

- WIDE GAIN AND ATTENUATION RANGE +31.5dB to -95.5dB with 0.5dB Steps
- LOW NOISE AND DISTORTION 120dB Dynamic Range 0.0004% THD+N at 1kHz (U-Grade) 0.0002% THD+N at 1kHz (A-Grade)
- NOISE-FREE LEVEL TRANSITIONS
- LOW INTERCHANNEL CROSSTALK –130dBFS
- POWER SUPPLIES: ±5V Analog, +5V Digital
- AVAILABLE IN DIP-16 AND SOL-16 PACKAGES
- PIN AND SOFTWARE COMPATIBLE WITH THE CRYSTAL CS3310

#### **APPLICATIONS**

- AUDIO AMPLIFIERS
- MIXING CONSOLES
- MULTI-TRACK RECORDERS
- BROADCAST STUDIO EQUIPMENT
- MUSICAL INSTRUMENTS
- EFFECTS PROCESSORS
- A/V RECEIVERS
- CAR AUDIO SYSTEMS

#### DESCRIPTION

The PGA2311 is a high–performance, stereo audio volume control designed for professional and high-end consumer audio systems. Using high performance operational amplifier stages internal to the PGA2311 yields low noise and distortion, while providing the capability to drive  $600\Omega$  loads directly without buffering. The 3-wire serial control interface allows for connection to a wide variety of host controllers, in addition to support for daisy-chaining of multiple PGA2311 devices.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.





#### ABSOLUTE MAXIMUM RATINGS(1)

| Supply Voltage, V <sub>A</sub> +            |
|---|
| V <sub>A</sub> 5.5V                         |
| V <sub>D</sub> + +5.5V                      |
| $V_A$ + to $V_D$ +                          |
| Analog Input Voltage                        |
| Digital Input Voltage                       |
| Operating Temperature Range –40°C to +85°C  |
| Storage Temperature Range65°C to +150°C     |
| Junction Temperature                        |
| Lead Temperature (soldering, 10s) +300°C    |
| Package Temperature (IR reflow, 10s) +235°C |

 Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability.

## ELECTROSTATIC DISCHARGE SENSITIVITY

This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

#### PACKAGE/ORDERING INFORMATION

| PRODUCT           | PACKAGE-LEAD | PACKAGE<br>DESIGNATOR(1) | OPERATING<br>TEMPERATURE<br>RANGE | PACKAGE<br>MARKING | ORDERING<br>NUMBER | TRANSPORT<br>MEDIA, QUANTITY |
|-------------------|--------------|--------------------------|-----------------------------------|--------------------|--------------------|------------------------------|
|                   | DIP-16       | N                        |                                   | PGA2311P           | PGA2311P           | Rails                        |
| PGA2311 (U-Grade) | SOL-16       | DW                       | -40°C to +85°C                    | PGA2311U           | PGA2311U           | Rails                        |
|                   |              |                          |                                   | PGA2311U           | PGA2311U/1K        | Tape and Reel, 1000          |
|                   | DIP-16       | N                        |                                   | PGA2311PA          | PGA2311PA          | Rails                        |
| PGA2311 (A-Grade) | 201 12       |                          | -40°C to +85°C                    | PGA2311UA          | PGA2311UA          | Rails                        |
|                   | SOL-16       | DW                       |                                   | PGA2311UA          | PGA2311UA/1K       | Tape and Reel, 1000          |

<sup>(1)</sup> For the most current specifications and package information, refer to our web site at www. ti.com.

#### **ELECTRICAL CHARACTERISTICS**

At  $T_A = +25^{\circ}C$ ,  $V_{A+} = +5V$ ,  $V_{A-} = -5V$ ,  $V_{D+} = +5V$ ,  $R_L = 100k\Omega$ ,  $C_L = 20pF$ , BW measure = 10Hz to 20kHz, unless otherwise noted.

|   |                                    | PGA2311P, U (U-Grade).       |        |                              | PGA2311PA, UA (A-Grade)      |        |                              |       |  |
|---|------------------------------------|------------------------------|--------|------------------------------|------------------------------|--------|------------------------------|-------|--|
| PARAMETER                               | CONDITIONS                         | MIN                          | TYP    | MAX                          | MIN                          | TYP    | MAX                          | UNITS |  |
| DC CHARACTERISTICS                      |                                    |                              |        |                              |                              |        |                              |       |  |
| Step Size                               |                                    |                              | 0.5    |                              |                              | 0.5    |                              | dB    |  |
| Gain Error                              | Gain Setting = 31.5dB              |                              | ±0.05  |                              |                              | ±0.05  |                              | dB    |  |
| Gain Matching                           |                                    |                              | ±0.05  |                              |                              | ±0.05  |                              | dB    |  |
| Input Resistance                        |                                    |                              | 10     |                              |                              | 10     |                              | kΩ    |  |
| Input Capacitance                       |                                    |                              | 3      |                              |                              | 3      |                              | pF    |  |
| AC CHARACTERISTICS                      |                                    |                              |        |                              |                              |        |                              |       |  |
| THD+N                                   | V <sub>IN</sub> = 2Vrms, f = 1kHz  |                              | 0.0004 | 0.001                        |                              | 0.0002 | 0.0004                       | %     |  |
| Dynamic Range                           | V <sub>IN</sub> = AGND, Gain = 0dB | 116                          | 120    |                              | 116                          | 120    |                              | dB    |  |
| Voltage Range, Output                   |                                    | (V <sub>A</sub> –) +<br>1.25 |        | (V <sub>A</sub> +) –<br>1.25 | (V <sub>A</sub> –) +<br>1.25 |        | (V <sub>A</sub> +) –<br>1.25 | V     |  |
| Voltage Range, Input (without clipping) |                                    |                              | 2.5    |                              |                              | 2.5    |                              | Vrms  |  |
| Output Noise                            | V <sub>IN</sub> = AGND, Gain = 0dB |                              | 2.5    | 4                            |                              | 2.5    | 4                            | μVrms |  |
| Interchannel Crosstalk                  | f = 1kHz                           |                              | -130   |                              |                              | -130   |                              | dBFS  |  |
| OUTPUT BUFFER                           |                                    |                              |        |                              |                              |        |                              |       |  |
| Offset Voltage                          | V <sub>IN</sub> = AGND, Gain = 0dB |                              | 0.25   | 0.5                          |                              | 0.25   | 0.5                          | mV    |  |
| Load Capacitance Stability              |                                    |                              | 100    |                              |                              | 100    |                              | pF    |  |
| Short-Circuit Current                   |                                    |                              | 50     |                              |                              | 50     |                              | mA    |  |
| Unity-Gain Bandwidth, Small Signal      |                                    |                              | 10     |                              |                              | 10     |                              | MHz   |  |

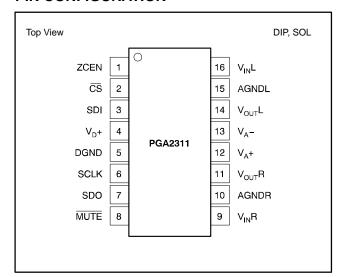


 $\begin{tabular}{ll} \textbf{ELECTRICAL CHARACTERISTICS (Cont.)} \\ \textbf{At T}_{A} = +25^{\circ}\text{C}, \ V_{A}+ = +5\text{V}, \ V_{D}+ = +5\text{V}, \ R_{L} = 100\text{k}\Omega, \ C_{L} = 20\text{pF}, \ \text{BW measure} = 10\text{Hz to 20kHz}, \ \text{unless otherwise noted}. \\ \end{tabular}$ 

|   | 001171710110             | PGA2                        | 311P, U (U- | Grade)           | PGA2311PA, UA (A-Grade)     |     |                  | шито  |
|---|--------------------------|-----------------------------|-------------|------------------|-----------------------------|-----|------------------|-------|
| PARAMETER                                 | CONDITIONS               | MIN                         | TYP         | MAX              | MIN                         | TYP | MAX              | UNITS |
| DIGITAL CHARACTERISTICS                   |                          |                             |             |                  |                             |     |                  |       |
| High-Level Input Voltage, VIH             |                          | +2.0                        |             | V <sub>D</sub> + | +2.0                        |     | V <sub>D</sub> + | V     |
| Low-Level Input Voltage, V <sub>IL</sub>  |                          | -0.3                        |             | 0.8              | -0.3                        |     | 8.0              | V     |
| High-Level Output Voltage, VOH            | I <sub>O</sub> = 200μA   | (V <sub>A</sub> +) –<br>1.0 |             |                  | (V <sub>D</sub> +) –<br>1.0 |     |                  | V     |
| Low-Level Output Voltage, VOL             | $I_{O} = -3.2 \text{mA}$ |                             |             | 0.4              |                             |     | 0.4              | V     |
| Input Leakage Current                     |                          |                             | 1           | 10               |                             | 1   | 10               | μΑ    |
| SWITCHING CHARACTERISTICS                 |                          |                             |             |                  |                             |     |                  |       |
| Serial Clock (SCLK) Frequency             | fSCLK                    | 0                           |             | 6.25             | 0                           |     | 6.25             | MHz   |
| Serial Clock (SCLK) Pulse Width LOW       | t <sub>PH</sub>          | 80                          |             |                  | 80                          |     |                  | ns    |
| Serial Clock (SCLK) Pulse Width HIGH      | t <sub>PL</sub>          | 80                          |             |                  | 80                          |     |                  | ns    |
| MUTE Pulse Width LOW                      | tMI                      | 2.0                         |             |                  | 2.0                         |     |                  | ms    |
| Input Timing                              | IVII                     |                             |             |                  |                             |     |                  |       |
| SDI Setup Time                            | t <sub>SDS</sub>         | 20                          |             |                  | 20                          |     |                  | ns    |
| SDI Hold Time                             | t <sub>SDH</sub>         | 20                          |             |                  | 20                          |     |                  | ns    |
| CS Falling to SCLK Rising                 | tCSCR                    | 90                          |             |                  | 90                          |     |                  | ns    |
| SCLK Falling to CS Rising                 | tCFCS                    | 35                          |             |                  | 35                          |     |                  | ns    |
| Output Timing                             | 0100                     |                             |             |                  |                             |     |                  |       |
| CS LOW to SDO Active                      | tcso                     |                             |             | 35               |                             |     | 35               | ns    |
| SCLK Falling to SDO Data Valid            | tCFDO                    |                             |             | 60               |                             |     | 60               | ns    |
| CS HIGH to SDO High Impedance             | tCSZ                     |                             |             | 100              |                             |     | 100              | ns    |
| POWER SUPPLY                              |                          |                             |             |                  |                             |     |                  |       |
| Operating Voltage                         |                          |                             |             |                  |                             |     |                  |       |
| V <sub>A</sub> +                          |                          | +4.75                       | +5          | +5.25            | +4.75                       | +5  | +5.25            | V     |
| V <sub>A</sub> -                          |                          | -4.75                       | <b>-</b> 5  | -5.25            | -4.75                       | -5  | -5.25            | V     |
| V <sub>D</sub> +                          |                          | +4.75                       | +5          | +5.25            | +4.75                       | +5  | +5.25            | V     |
| Quiescent Current                         |                          |                             |             |                  |                             |     |                  |       |
| I <sub>A</sub> +                          | $V_A + = +5V$            |                             | 8           | 10               |                             | 8   | 10               | mA    |
| IA-                                       | V <sub>A</sub> = -5V     |                             | 10          | 12               |                             | 10  | 12               | mA    |
| ID+                                       | $V_{D} + = +5V$          |                             | 0.5         | 1.0              |                             | 0.5 | 1.0              | mA    |
| Power-Supply Rejection Ratio PSRR (250Hz) |                          |                             | 100         |                  |                             | 100 |                  | dB    |
| TEMPERATURE RANGE                         |                          |                             |             |                  |                             |     |                  |       |
| Operating Range                           |                          | -40                         |             | +85              | -40                         |     | +85              | °C    |
| Storage Range                             |                          | -65                         |             | +150             | -65                         |     | +150             | °C    |
| Thermal Resistance, JC                    |                          |                             |             |                  |                             |     |                  |       |
| DIP-16                                    |                          |                             | 60          |                  |                             | 60  |                  | °C/W  |
| SOL-16                                    |                          |                             | 50          |                  |                             | 50  |                  | °C/W  |



#### **PIN CONFIGURATION**



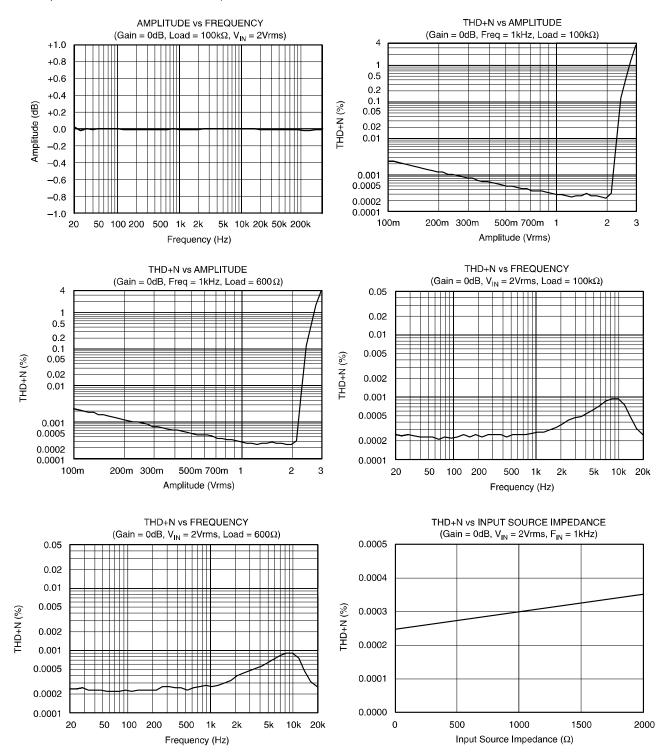
#### **PIN ASSIGNMENTS**

| PIN | NAME              | FUNCTION                                 |
|-----|-------------------|--|
| 1   | ZCEN              | Zero Crossing Enable Input (Active HIGH) |
| 2   | CS                | Chip Select Input (Active LOW)           |
| 3   | SDI               | Serial Data input                        |
| 4   | V <sub>D</sub> +  | Digital Power Supply, +5V                |
| 5   | DGND              | Digital Ground                           |
| 6   | SCLK              | Serial Clock Input                       |
| 7   | SDO               | Serial Data Output                       |
| 8   | MUTE              | Mute Control Input (Active LOW)          |
| 9   | VINR              | Analog Input, Right Channel              |
| 10  | AGNDR             | Analog Ground, Right Channel             |
| 11  | VoutR             | Analog Output, Right Channel             |
| 12  | V <sub>A</sub> +  | Analog Power Supply, +5V                 |
| 13  | VA-               | Analog Power Supply, -5V                 |
| 14  | $V_{OUT}L$        | Analog Output, Left Channel              |
| 15  | AGNDL             | Analog Ground, Left Channel              |
| 16  | V <sub>IN</sub> L | Analog Input, Left Channel               |



#### TYPICAL CHARACTERISTICS

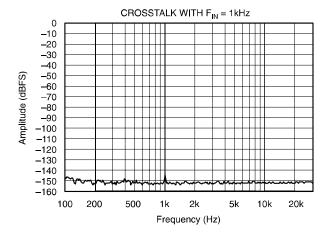
At  $T_A = +25^{\circ}C$ ,  $V_A + = +5V$ ,  $V_A - = -5V$ ,  $V_D + = +5V$ ,  $R_L = 100k\Omega$ ,  $C_L = 20pF$ , BW measure = 10Hz to 20kHz, unless otherwise noted. (NOTE: All plots taken with PGA2311 A–Grade.)

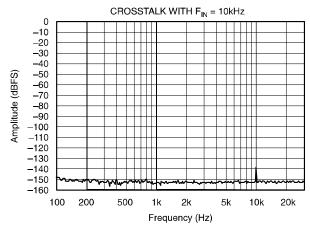


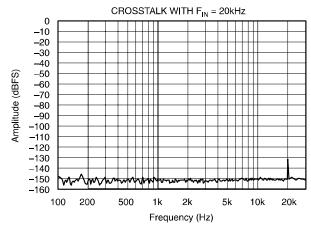


#### **TYPICAL CHARACTERISTICS (CONT.)**

At  $T_A$  = +25°C,  $V_A$ + = +5V,  $V_A$ - = -5V,  $V_D$ + = +5V,  $R_L$  = 100k $\Omega$ ,  $C_L$  = 20pF, BW measure = 10Hz to 20kHz, unless otherwise noted. (NOTE: All plots taken with PGA2311 A–Grade.)









#### GENERAL DESCRIPTION

The PGA2311 is a stereo audio volume control. It may be used in a wide array of professional and consumer audio equipment. The PGA2311 is fabricated in a submicron CMOS process.

The heart of the PGA2311 is a resistor network, an analog switch array, and a high–performance op amp stage. The switches are used to select taps in the resistor network that, in turn, determine the gain of the amplifier stage. Switch selections are programmed using a serial control port. The serial port allows connection to a wide variety of host controllers. Figure 1 shows a functional block diagram of the PGA2311.

#### **POWER-UP STATE**

On power up, "power–up reset" is activated for about 100ms during which the circuit is in hardware MUTE state and all internal flip-flops are reset. At the end of this period, the offset calibration is initiated without any external signals. Once this has been completed, the gain byte value for both the left and right channels are set to 00<sub>HEX</sub>, or the software MUTE condition. The gain will remain at this setting until the host controller programs new settings for for each channel via the serial control port.

If during normal operation the power supply voltage drops below ±3.2V, the circuit enters a hardware MUTE state. A power-up sequence will be initiated if the power supply voltage returns to greater than ±3.2V.

#### **ANALOG INPUTS AND OUTPUTS**

The PGA2311 includes two independent channels, referred to as the left and right channels. Each channel has a corresponding input and output pin. The input and output pins are unbalanced, or referenced to analog ground (either AGNDR or AGNDL). The inputs are named  $V_{INR}$  (pin 9) and  $V_{INL}$  (pin 16), while the outputs are named  $V_{OUTR}$  (pin 11) and  $V_{OUTL}$  (pin 14).

The input and output pins may swing within 1.25V of the analog power supplies,  $V_A+$  (pin 12) and  $V_A-$  (pin 13). Given  $V_A+=+5V$  and  $V_A-=-5V$ , the maximum input or output voltage range is 7.5Vp-p.

For optimal performance, it is best to drive the PGA2311 with a low source impedance. A source impedance of  $600\Omega$  or less is recommended. Source impedances up to  $2k\Omega$  will cause minimal degradation of THD+N. Please refer to the "THD+N vs Source Impedance" plot in the Typical Characteristics section of the datasheet.

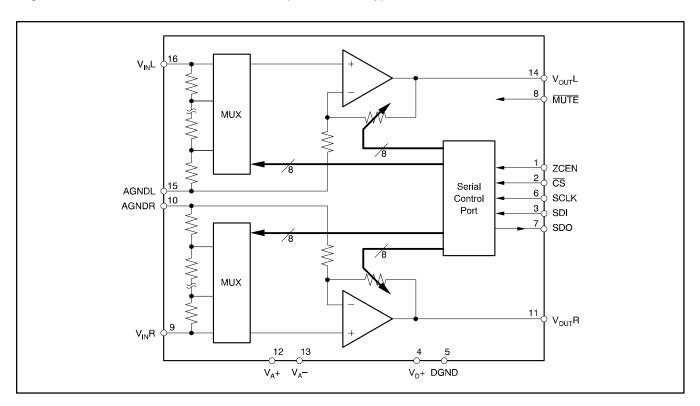


Figure 1. PGA2311 Block Diagram.



#### **SERIAL CONTROL PORT**

The serial control port is utilized to program the gain settings for the PGA2311. The serial control port includes three input pins and one output pin. The inputs include  $\overline{CS}$  (pin 2), SDI (pin 3), and SCLK (pin 6). The sole output pin is SDO (pin 7).

The  $\overline{\text{CS}}$  pin functions as the chip select input. Data may be written to the PGA2311 only when  $\overline{\text{CS}}$  is LOW. SDI is the serial data input pin. Control data is provided as a 16-bit word at the SDI pin, 8 bits each for the left and right channel gain settings.

Data is formatted as MSB first, straight binary code. SCLK is the serial clock input. Data is clocked into SDI on the rising edge of SCLK.

SDO is the serial data output pin, and is used when daisy-chaining multiple PGA2311 devices. Daisy-chain operation is described in detail later in this section. SDO is a tri-state output, and assumes a high impedance state when  $\overline{\text{CS}}$  is HIGH.

The protocol for the serial control port is shown in Figure 2. See Figure 3 for detailed timing specifications for the serial control port.

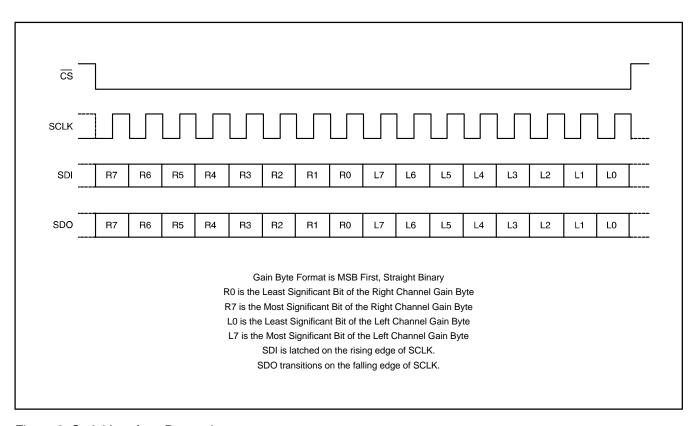


Figure 2. Serial Interface Protocol.



#### **GAIN SETTINGS**

The gain for each channel is set by its corresponding 8-bit code, either R[7:0] or L[7:0] (see Figure 2). The gain code data is straight binary format. If we let N equal the decimal equivalent of R[7:0] or L[7:0], then the following relationships exist for the gain settings:

For N = 0:

Mute Condition. The input multiplexer is connected to analog ground (AGNDR or AGNDL).

For N = 1 to 255:

Gain (dB) = 
$$31.5 - [0.5 \text{ w} (255 - \text{N})]$$

This results in a gain range of +31.5dB (with N = 255) to -95.5dB (with N = 1).

Changes in gain setting may be made with or without zero crossing detection. The operation of the zero crossing detector and timeout circuitry is discussed later in this data sheet.

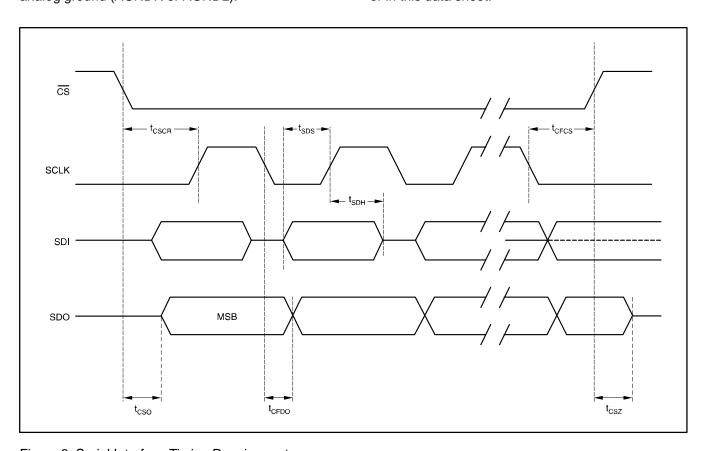


Figure 3. Serial Interface Timing Requirements.



#### DAISY-CHAINING MULTIPLE PGA2311 DEVICES

In order to reduce the number of control signals required to support multiple PGA2311 devices on a printed circuit board, the serial control port supports daisy-chaining of multiple PGA2311 devices. Figure 4 shows the connection requirements for daisy-chain operation. This arrangement allows a 3-wire serial interface to control many PGA2311 devices.

As shown in Figure 4, the SDO pin from device #1 is connected to the SDI input of device #2, and is repeated for additional devices. This in turn forms a large shift register, in which gain data may be written for all PGA2311s connected to the serial bus. The length of the shift register is 16 • N bits, where N is equal to the number of PGA2311 devices included in the chain. The  $\overline{\text{CS}}$  input must remain LOW for 16 • N SCLK periods, where N is the number of devices connected in the chain, in order to allow enough SCLK cycles to load all devices.

#### ZERO CROSSING DETECTION

The PGA2311 includes a zero crossing detection function that can provide for noise-free level transitions. The concept is to change gain settings on a zero crossing of the input signal, thus minimizing audible glitches. This function is enabled or disabled using the ZCEN input (pin 1). When ZCEN is LOW, zero crossing detection is disabled. When ZCEN is HIGH, zero crossing detection will be enabled.

The zero crossing detection takes effect with a change in gain setting for a corresponding channel. The new gain setting will not be implemented until either positive slope zero crossing is detected or a time-out period of 16ms has elapsed. In the case of a time-out, the new gain setting takes effect with no attempt to minimize audible artifacts.

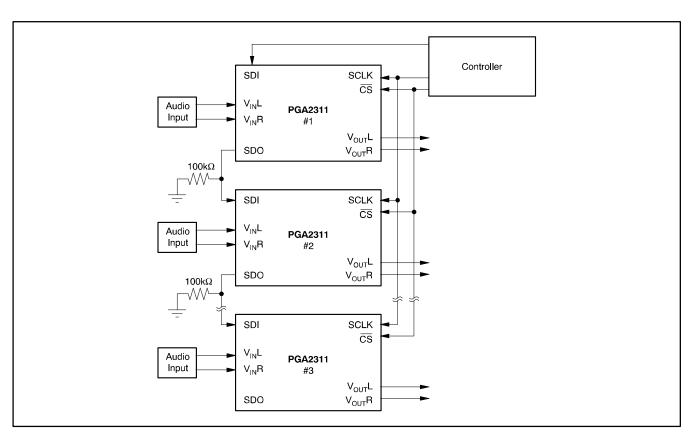


Figure 4. Daisy-Chaining Multiple PGA2311 Devices.



#### **MUTE FUNCTION**

Muting can be achieved by either hardware or software control. Hardware muting is accomplished via the MUTE input, and software muting by loading all zeroes into the volume control register.

 $\overline{\text{MUTE}}$  disconnects the internal buffer amplifiers from the output pins and terminates A<sub>OUT</sub>L and A<sub>OUT</sub>R with 10kΩ resistors to ground. The mute is activated with a zero crossing detection (independent of the zero cross enable status) or an 16ms time-out to eliminate any audible "clicks" or "pops".  $\overline{\text{MUTE}}$  also initiates an internal offset calibration.

A software mute is implemented by loading all zeroes into the volume control register. The internal amplifier is set to unity gain with the amplifier input connected to AGND.

#### APPLICATIONS INFORMATION

This section includes additional information that is pertinent to designing the PGA2311 into an end application.

#### RECOMMENDED CONNECTION DIAGRAM

Figure 5 depicts the recommended connections for the PGA2311. Power-supply bypass capacitors should be placed as close to the PGA2311 package as physically possible.

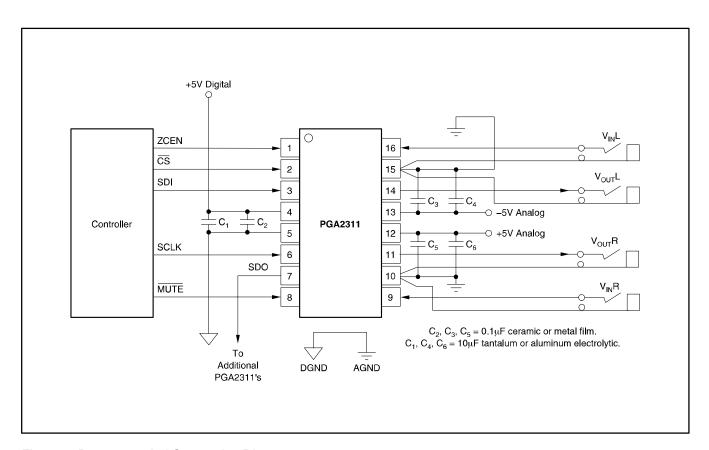


Figure 5. Recommended Connection Diagram.



### PRINTED CIRCUIT BOARD (PCB) LAYOUT GUIDELINES

It is recommended that the ground planes for the digital and analog sections of the PCB be separate from one another. The planes should be connected at a single point. Figure 6 shows the recommended PCB floor plan for the PGA2311. The PGA2311 is mounted so that it straddles the split between the digital and analog ground planes. Pins 1 through 8 are oriented to the digital side of the board, while pins 9 through 16 are on the analog side of the board.

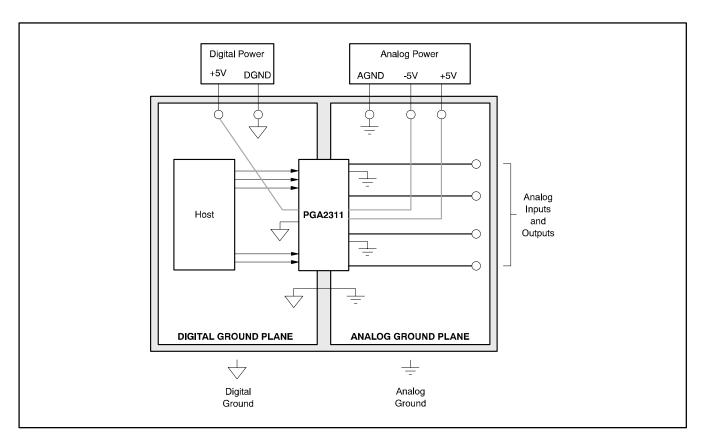


Figure 6. Typical PCB Layout Floor Plan.

PLASTIC DUAL-IN-LINE PACKAGE

0.850

0.940



#### **PACKAGE DRAWINGS**

MPDI002B ± JANUARY 1995 ± REVISED FEBRUARY 2000

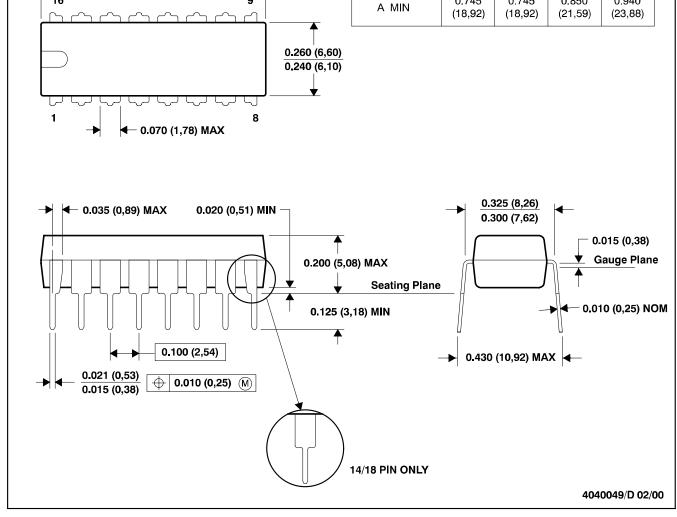
#### N (R-PDIP-T\*\*)

#### **16 PINS SHOWN**

16

# PINS \*\* 14 16 18 20 MAX 0.775 0.775 0.920 0.975 (19,69) (19,69) (23,37) (24,77)

0.745



DIM

A MAX

0.745

- NOTES: A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MS-001 (20-pin package is shorter than MS-001).

9



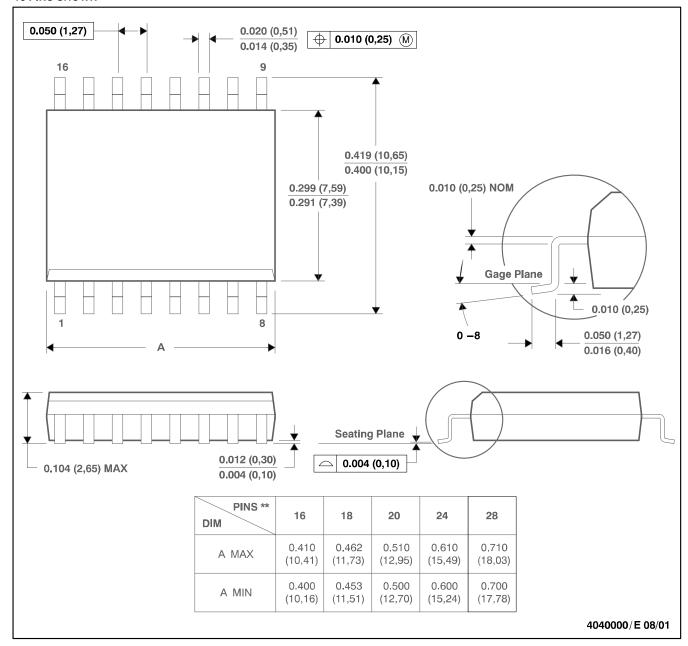
#### **PACKAGE DRAWINGS (Cont.)**

MSOI003E - JANUARY 1995 - REVISED SEPTEMBER 2001

#### DW (R-PDSO-G\*\*)

#### **16 PINS SHOWN**

#### PLASTIC SMALL-OUTLINE PACKAGE



- NOTES: A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - D. Falls within JEDEC MS-013





i.com 3-Oct-2005

#### **PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package<br>Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan <sup>(2)</sup>    | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|-----------------|--------------------|------|----------------|----------------------------|------------------|------------------------------|
| PGA2311P         | ACTIVE                | PDIP            | N                  | 16   | 25             | TBD                        | CU SNPB          | Level-NA-NA-NA               |
| PGA2311PA        | ACTIVE                | PDIP            | N                  | 16   | 25             | TBD                        | CU SNPB          | Level-NA-NA-NA               |
| PGA2311U         | ACTIVE                | SOIC            | DW                 | 16   | 48             | TBD                        | CU NIPDAU        | Level-3-220C-168 HR          |
| PGA2311U/1K      | ACTIVE                | SOIC            | DW                 | 16   | 1000           | TBD                        | CU NIPDAU        | Level-3-220C-168 HR          |
| PGA2311U/1KG4    | ACTIVE                | SOIC            | DW                 | 16   | 1000           | Green (RoHS &<br>no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |
| PGA2311UA        | ACTIVE                | SOIC            | DW                 | 16   | 48             | TBD                        | CU NIPDAU        | Level-3-220C-168 HR          |
| PGA2311UA/1K     | ACTIVE                | SOIC            | DW                 | 16   | 1000           | TBD                        | CU NIPDAU        | Level-3-220C-168 HR          |
| PGA2311UG4       | ACTIVE                | SOIC            | DW                 | 16   | 48             | Green (RoHS &<br>no Sb/Br) | CU NIPDAU        | Level-3-260C-168 HR          |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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